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Fabrication Method:

Molded

Body Mounting Hole Accommodation Diameter:

0.252 inches

Mounting Hole Style:

Round, flatted

Specific Equipment Accommodated:

Semiconductor device

Contact Material:

Copper alloy

Contact Surface Treatment:

Silver

Accommodated Contact Quantity:

3

Polarization Type:

Contact position

Distance From Flatted Portion To Opposite Surface:

0.232 inches

Mounting Method:

Press fit

Mounting Type For Which Designed:

Chassis

Features Provided:

Component retaining device

Contact Position Arrangement Style:

Circular irregular 0.100 inch

Terminal Type And Quantity:

3 tab, solder lug

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

No

Fig:

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